## KEMET Part Number: C1210X224J3GAC



## SMD Comm COG Flex, Ceramic, 0.22 uF, 5%, 25 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1210



Dimensions		
Chip Size	1210	
L	3.3mm +/-0.4mm	
W	2.6mm +/-0.3mm	
Т	2.1mm +/-0.20mm	
В	0.6mm +/-0.25mm	

Packaging Specifications		
Packaging:	Bulk, Bag	
Packaging Quantity:	1	

General Information		
Series:	SMD Comm C0G Flex	
Style:	SMD Chip	
Description:	SMD, MLCC, FT-CAP, Ultra- Stable	
Features:	FT-CAP, Ultra-Stable	
RoHS:	Yes	
Termination:	Flexible Termination	
Marking:	No	
AEC-Q200:	No	
Component Weight:	78 mg	
Shelf Life:	78 Weeks	
MSL:	1	

Specifications		
Capacitance:	0.22 uF	
Measurement Condition:	1 kHz 1.0Vrms	
Capacitance Tolerance:	5%	
Voltage DC:	25 VDC	
Dielectric Withstanding Voltage:	62.5 VDC	
Temperature Range:	-55/+125°C	
Temperature Coefficient:	COG	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms	
Dissipation Factor:	0.1% 1 kHz 1.0Vrms	
Aging Rate:	0% Loss/Decade Hour	
Insulation Resistance:	4.5455 GOhms	

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